Electroluminescence from a diamond device with ion-beam-micromachined buried graphitic electrodes

J. Forneris\textsuperscript{a,b,c,*}, A. Battiato\textsuperscript{a,b,c}, D. Gatto Monticone\textsuperscript{a,b,c}, F. Picollo\textsuperscript{b,c,a}, G. Amato\textsuperscript{d}, L. Boarino\textsuperscript{d}, G. Brida\textsuperscript{d}, I. P. Degiovanni\textsuperscript{d}, E. Enrico\textsuperscript{d}, M. Genovese\textsuperscript{d}, E. Moreva\textsuperscript{d}, P. Traina\textsuperscript{d}, C. Verona\textsuperscript{a}, G. Verona Rinati\textsuperscript{e}, P. Olivero\textsuperscript{a,b,c}

\textsuperscript{a}Physics Department and NIS Interdepartmental Centre, University of Torino, Torino, Italy
\textsuperscript{b}Istituto Nazionale di Fisica Nucleare (INFN), Sez. Torino, Torino, Italy
\textsuperscript{c}Consorzio Nazionale Interuniversitario per le Scienze Fisiche della Materia (CNISM), Sez. Torino, Torino, Italy
\textsuperscript{d}Istituto Nazionale di Ricerca Metrologica (INRiM), Torino, Italy
\textsuperscript{e}Department of Industrial Engineering, University of Roma "Tor Vergata", Roma, Italy

1. Introduction

Color centers in diamond are attracting an ever-growing interest due to their appealing photon-emission properties (high stability and quantum efficiency at room temperature) for applications in quantum optics and photonics [1].

The development of diamond devices based on the functionalities of sub-superficial graphitic micro-electrodes has been investigated in several recent works [2,3]. The fabrication method relies on the direct writing in the single-crystal diamond bulk of amorphized channels by the selective damage induction associated with the Bragg’s peak of MeV ions. The crystal volume in which the radiation-induced vacancy density exceeds a threshold value converts to nano-crystalline graphite upon thermal treatment at temperatures above 900 °C, while the diamond lattice is partially recovered where the radiation damage density is lower [4,5].

Since the radiation damage from MeV ions is prominently induced at the ion end of range, the fabrication method has been proved to be effective for the fabrication of conductive graphitic electrodes located several micrometers below the surface of the electrically insulating and optically transparent diamond dielectric. The fabrication process is characterized by a spatial resolution which is limited only by the ion beam spot size and by the ion lateral straggling in the material. The technique has been effectively...
exploited to fabricate and characterize diamond-based devices such as ionizing radiation detectors \[3,6\] cellular bio-sensors \[7\] and IR emitters \[8\].

In this work, we investigate the potential exploitation of the fabrication technique for the electrical excitation of color centers in diamond, aiming at the development of practical single-photon-emitting devices based on the efficiency and stability of the above-mentioned centers, for applications in quantum optics \[9,10\].

With this purpose, a diamond device with four independent buried graphitic electrodes was fabricated by means of MeV ion beam lithography. Differently from previous works, in which the electrical excitation of color centers is achieved by means of diodes and p-i-n structures \[9–11\], the device proposed in this work exploits the current flowing between buried graphitic electrodes, in order to obtain electroluminescence (EL) from the diamond region located in the inter-electrode gap. The light emission properties of the fabricated structure were investigated by means of luminescence mapping and the relevant spectra were analyzed to attribute the active defects in the device under investigation.

2. Experimental

2.1. Sample preparation

The device under test, whose IBIC characterization was previously reported in \[6\], is based on a \(\sim 40 \mu m\) thick intrinsic diamond film homoepitaxially grown on a commercially available \(4 \times 4 \times 0.4 \text{ mm}^3\) type-Ib single-crystal high-pressure high-temperature (HPHT) substrate, using a microwave plasma enhanced chemical vapor deposition process at the laboratories of Rome “Tor Vergata” University. A scanning 1.8 MeV He\(^{+}\) ion microbeam \((\sim 10 \mu m\) spot size) was used to perform a deep ion beam lithography (DIBL) process \[2,6\] at the AN2000 micro-beam line of the INFN National Laboratories of Legnaro (I). Five graphitic channels were written at a depth of \(\sim 3 \mu m\) below the diamond surface using a ion fluence of \(1.5 \times 10^{17} \text{ cm}^{-2}\), which, according to SRIM2011 simulations \[12\], is sufficient to achieve a vacancy density above the graphitization threshold at the end of range (Fig. 1a) \[6\].

Before the DIBL process, a slowly thinning copper mask was deposited on the diamond surface in order to control the depth of the 1.8 MeV He\(^{+}\) Bragg’s peak in diamond, ensuring the emersion of the buried graphitic channels at their endpoints, as described in previous works \[2,3,6\].

The implanted sample underwent a thermal annealing process for 2 h in vacuum, in order to promote the conversion of the amorphized regions at the end of the Bragg’s peak to a graphitic phase and to concurrently recover the residual structural damage in the region comprised between the buried channels and the diamond surface. The resulting micro-fabricated structure (Fig. 1b) consisted of four parallel, \(\sim 10 \mu m\) wide independent graphitic electrodes, spaced by \(\sim 12 \mu m\), plus an additional horizontal electrode, which was not employed in the present work. Each graphitic channel was connected to the external circuitry by the deposition of 80 nm thick Cr/Al circular contacts (150 \(\mu m\) diameter), which were exploited as pads for the electrodes wire-bonding. As schematically represented in Fig. 1b, the graphitic channels were shorted in pairs, defining a two-electrode inter-digitated geometry. Due to the ion micro-beam spot size and to the absence of an implantation mask, stray ions were implanted in the inter-electrode gap, with an estimated fluence at the gap center of \(\sim 1 \times 10^{15} \text{ cm}^{-2}\), i.e., two orders of magnitude below the graphitization threshold.

An electrical characterization of the fabricated structure was performed by means of current–voltage measurements (Fig. 2a) between the two independent electrodes (experimental parameters: 2-terminal configuration, 0–500 V voltage range, 3 s source time and 2 V voltage step). The measured current was lower than 100 pA at ±100 V applied bias, thus confirming the mutual insulation of the electrodes through the annealed diamond matrix and indicating a negligible surface leakage current. Particularly, such result evidenced that the thermal annealing effectively prevented the residual radiation damage associated with stray ions implanted in the electrodes gap from affecting the overall insulation properties of the material.

On the other hand, at applied voltages larger than +400 V an abrupt current increase to few hundreds of nA was observed, and the current reached values of tens of \(\mu A\) at +500 V. Such phenomenon was repeatable and non-destructive for the sample under test. EL was observed with the transition to the high-current regime along a straight path connecting two buried electrodes (Fig. 2b), suggesting that the sudden current increase is caused by the injection of charge carriers at localized sites at the interface between diamond and graphite. Furthermore, the \(I–V\) characteristic showed an hysteretical behavior, with higher current values at decreasing bias than those exhibited at increasing voltages. The reported observations indicate a different behavior from what reported in a previous work on the characterization of graphitic channels in diamond, where the \(I–V\) characteristic was interpreted in terms of an avalanche breakdown \[5\]; therefore, further

![Fig. 1.](image-url)
investigations will be necessary to unequivocally interpret the charge conduction mechanism in the device under test.

2.2. Optical characterization

The electric current flowing between the buried channels was exploited to provide the electrical excitation of the color centers in the inter-electrode gap. A bright EL emission, visible to the bare eye, typically appeared at currents above ~100 nA and increased in intensity at increasing bias. In Fig. 2b, an optical micrograph of the inter-electrode region of the sample taken at a bias voltage of +450 V is shown, where EL is clearly visible, and the presence of different spectral components of the emitted light is apparent.

In order to clarify the emission properties of the electroluminescent device and to identify with higher spatial resolution the light-emitting regions of the structure, an EL mapping of the sample was performed by adapting a home-built confocal photoluminescence microscopy setup (Fig. 3a) [13]. The sample was mounted on a remotely-controlled three-axis piezo-electric stage, with a scan area of 100 × 100 μm² and a nanometer positioning accuracy, and was raster-scanned to image the EL properties of the structure under test. The induced luminescence was collected by a 100× air objective (numerical aperture N.A. = 0.9) and then focused with an achromatic doublet into a graded-index multimode optical fiber, which both provided an optical connection to the detection system and acted as the pinhole aperture for the confocal system. The detection system consisted of a photon-counter based on one Si-single-photon-avalanche photo-diode (SPAD) Perkin–Elmer SPCARQ14-FC operating in Geiger mode; a digital counter recorded the total counts detected by the SPAD, enabling the measurement of the total EL intensity for each pixel.

3. Results

An EL map acquired at a bias voltage of 450 V is shown in Fig. 3b. The encoded color scale displays for clarity a maximum emission rate value of 5 × 10⁴ counts per second (cps), each count corresponding to the detection of a single photon; however, the values recorded at the center of the bright spot reached values larger than 10⁶ cps. The map clearly shows that the electroluminescent region corresponds to a localized conduction path connecting the buried electrodes (highlighted by the dashed black lines in Fig. 3b). The conductive path corresponds to the bright region highlighted in the optical micrograph in Fig. 2 and originates at the endpoint of the grounded electrode, where the sharpening of the buried graphitic channel increases the local electric field as an effect of the tip geometry.

With the purpose of performing spectroscopic measurements, the radiation from the light-emitting region highlighted by the green circle in Fig. 2, comprising most of the EL signal was collected with a Jobin Yvon Raman micro-spectrometer equipped with a CCD Andor “DU420A-OE” detector. As the light emission is not stimulated by a localized standard laser excitation, but instead is induced by the electrical current flowing between the electrodes, the collected light is not spatially limited to the focal point of the experimental setup and the spatial resolution for the spectral measurement was estimated to be of ~10 μm. A typical EL spectrum is shown in Fig. 4. The two dips at 633 nm and at...
428 nm are instrumental artifacts caused by the presence of a notch filter mounted in the spectrometer, which attenuates the laser excitation when the setup operates in its usual configuration. Starting from lower wavelengths, different features can be identified in the EL spectrum. Firstly, a ~100 nm broad peak centered at 435 nm is visible. The broad peak is usually referred as the A-band and its origin is commonly attributed to radiative carriers recombination at extended lattice dislocations. Evidence of the A-band was found in previous EL experiments in diamond P-I-N junctions [11,14,15]. Therefore, the observation of the 435 nm broad peak proves that the injected charge carriers are interacting with electronic states within the bandgap [14]. Secondly, the two sharp peaks at 536.3 nm and 560.5 nm are attributed to a helium-related defect previously observed in cathodoluminescence [5,15], consistently with the fact that He+ was employed for the micro-fabrication process. Furthermore, the results highlight the possibility of electrically stimulating isolated He-related defects may open the study of new electroluminescent single-photon sources in diamond for applications in photonics and quantum information.

4. Conclusions

A structure consisting of parallel buried graphitic electrodes in single-crystal diamond was fabricated with DBL with a 1.8 MeV He+ scanning microbeam. The current flowing in the gap region between the buried electrodes has been exploited to stimulate EL from color centers located in the above-mentioned region. EL mapping highlighted that the emission occurs along localized paths between the electrodes. The EL spectrum exhibited light emission from dislocation clusters (A-band), NV0 centers and helium-related defects associated with the ion implantation. The results presented in this work confirm that it is possible to electrically excite color centers by means of charge injection from graphitic non-rectifying electrodes, although a deeper investigation of the electrical properties of the electrodes geometry under test will be required to shed light on the charge injection and the charge transport properties of the device.

Furthermore, the results highlight the possibility of electrically exciting He-related defects, which are characterized by appealing photophysical properties, i.e. high emission rates, sharp spectral emission, negligible phononic sidebands. The possibility to identify and electrically stimulate isolated He-related defects might open the study of new electroluminescent single-photon sources in diamond for applications in photonics and quantum information.

Acknowledgements

This work is supported by the following projects: FIRB “Futuro in Ricerca 2010” (CUP code: D11J10004500001) funded by the Italian Ministry for Teaching, University and Research (MIUR); “ADLN-Tech.” project (CUP code: D15E13000130003) funded by the University of Turin and Compagnia di San Paolo in the framework of the ‘Progetti di ricerca di Ateneo 2012’ scheme; EMRP project ‘EXL02-SIQUE’ jointly funded by the EMRP participating countries within EURAMET and the European Union.

References